

Message

From: Ramanauskas, Peter [/O=EXCHANGELABS/OU=EXCHANGE ADMINISTRATIVE GROUP (FYDIBOHF23SPDLT)/CN=RECIPIENTS/CN=6492DDC4240C482B891D9F48B06E17F6-PRAMANAU]
Sent: 11/8/2017 6:16:37 PM
To: Steketee, John [steketee.john@epa.gov]; Kenneth Zolnierczyk [Zolnierczyk.Kenneth@epa.gov]
Subject: FW: Suggested Format for FOIA Request for PCB Investigation and Remediation

Heads up. Incoming FOIA at some point.

From: Steven Klafka [mailto:sklafka@wingraengineering.com]
Sent: Wednesday, November 08, 2017 12:06 PM
To: Ramanauskas, Peter <ramanauskas.peter@epa.gov>
Subject: Suggested Format for FOIA Request for PCB Investigation and Remediation

Peter,

I would like to submit a FOIA request for meeting minutes related to USEPA discussion of the investigation and remediation of the PCB contamination under the Madison-Kipp Corporation factory in Madison, WI.

How should I refer to this project to assure the correct information is requested?

Thanks for your assistance.

Steven Klafka

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